

2/19/04

02-23-2004



To the Honorable Commissioner of Patents and Trademarks - 102675308

and original documents or copy thereof.

1. Name of conveying party(ies):
Joachim Schnabel
Andre Schaefer
Xaver Obergrussberger
Sebastian Mosler
Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)
Name: INFINEON TECHNOLOGIES AG
Internal Address: _____
Street Address: St.-Martin-Str. 53
81669 Munchen, GERMANY
City: _____ State: _____ Zip: _____
Additional name(s) & address(es) attached? Yes No

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3. Nature of conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other _____
Execution Date: Jan 14, '04

4. Application number(s) or patent number(s):
If this document is being filed together with a new application, the execution date of the application is: _____
A. Patent Application No.(s) 10/663,354
B. Patent No.(s) _____
Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:
Name: Jacqueline M. Arendt
Internal Address: _____
Street Address: Arendt & Associates IP Group
1740 Massachusetts Avenue
City: Boxborough State: MA Zip: 01719-2209

6. Total number of applications and patents involved:
7. Total fee (37 CFR 3.41).....\$ 40.00
 Enclosed
 Authorized to be charged to deposit account
8. Deposit account number: _____

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9. Signature.
Jacqueline M. Arendt -(Reg. No. 43,474)
Name of Person Signing
Signature
February 14, 2004
Date
Total number of pages including cover sheet, attachments, and documents: 6 (plus postcard and check) JMA

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Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231

Joint

ASSIGNMENT

WHEREAS, we, **Joachim Schnabel, Andre Schaefer, Xaver Obergrussberger, and Sebastian Mosler**, have invented a certain improvement in: **Arrangement of Several Resistors Jointly Positioned In a Well Of a Semiconductor Device, and a Semiconductor Device Including At Least one Such Arrangement**, described in an application for Letters Patent of the United States, the specification of which:

- is being executed on even date herewith and is about to be filed in the United States Patent Office;
- was filed on **September 16, 2003** as Application No. **10/663,354**;
- was patented under U.S. Patent No. [] on [].

WHEREAS, **INFINEON TECHNOLOGIES AG** (hereinafter "ASSIGNEE"), a corporation organized and existing under the laws of GERMANY and having an usual place of business at St.-Martin-Str.53, 81669 Munchen, GERMANY, desires to acquire an interest therein in accordance with agreements duly entered into with us;

NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, we have sold, assigned and transferred and by these presents do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to said invention as described in said application, and to improvements in said invention, together with the entire right, title and interest in and to said application and all divisions, renewals and continuations thereof, and such Letters Patent as may issue thereon; said invention, application and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by us had this assignment and sale not been made; we hereby convey all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent. We hereby acknowledge that this assignment, being of the entire right, title and interest in and to said invention, carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all such Letters Patent to ASSIGNEE for its own name as assignee of the entire right, title and interest therein;

AND, we hereby further agree for ourselves and our executors and administrators to execute upon request any other lawful documents and likewise to perform any other lawful acts which may be deemed necessary to secure fully the aforesaid invention to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including the execution of applications for patents in foreign countries, and the execution of substitution, reissue, divisional or continuation applications and preliminary or other statements and the giving of testimony in any interference or other proceeding in which said invention or any application or patent directed thereto may be involved;

AND, we do hereby authorize and request the Commissioner of Patents of the United States, any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue such Letters Patent as shall be granted upon said application or applications based thereon to said ASSIGNEE, its successors, assigns, and legal representatives.

Inventor	<i>Joachim Schnabel</i> Joachim Schnabel	Date	01/14/04
Address	Stadelheimer Str. 25 81549 München, GERMANY		

Witness	Rory Dickmann	<i>[Signature]</i>
Address	Rehässchen 4 93047 Regensburg (Germany)	

Witness	Günter Gerstmeier	<i>[Signature]</i>
Address	Schulstr. 14a 86567 Hilg.-Taudern	

Inventor	<i>Andre Schaefer</i> Andre Schaefer	Date	1/14/04
Address	Waisenhausstr. 54 80637 München, GERMANY		

Witness	Boris Barff	<i>[Signature]</i>
Address	Finkenweg 1 83064 Raubling	

Witness	Xavier Obenpaußberger	<i>[Signature]</i>
Address	Hochstr. 16 84568 Pleiskirchen	

Inventor	<i>Xaver Obergrussberger</i> Xaver Obergrussberger	Date	<i>14. Jan 2004</i>
Address	Hochstrass 16 84568 Pleiskirchen, GERMANY		

Witness	<i>Denis Bort</i>
Address	<i>Finkenweg 1</i> <i>83064 Raupling</i>
Witness	<i>Andreas Sailer</i>
Address	<i>Weissenhausstr. 54</i> <i>80637 München</i>

Inventor	Sebastian Mosler	Date	
Address	Rollenhagenstr. 21 81739 München, GERMANY		

Witness	
Address	

Witness	
Address	

Inventor		Date	
	Xaver Obergrussberger		
Address	Hochstrass 16 84568 Pleiskirchen, GERMANY		

Witness	
Address	

Witness	
Address	

Inventor		Date	14-1-09
	Sebastian Mosler		<i>S. Mosler</i>
Address	Hörigstrasse 29 01157 Dresden, GERMANY		

Witness	<i>A. Thies</i>
Address	<i>Andreas Thies, Infineon Dresden, Königsbrücker Str. 18b, Dresden</i>

Witness	<i>D. Jannicke</i>
Address	<i>Pfuhser Weg 14, 01109 Dresden</i>